

PCN# 20200727000.1 Qualification of RFAB as an additional Fab site option for select LBC7 devices Change Notification / Sample Request

Date:August 03, 2020To:Newark/Farnell PCN

Dear Customer:

This is an announcement of a change to a device that is currently offered by Texas Instruments. The details of this change are on the following pages.

Texas Instruments requires acknowledgement of receipt of this notification within **30** days of the date of this notice. Lack of acknowledgement of this notice within 30 days constitutes acceptance of the change. If samples or additional data are required, requests must be received within **30 days** of this notification.

The changes discussed within this PCN will not take effect any earlier than the proposed first ship date on Page 3 of this notification, unless customer agreement has been reached on an earlier implementation of the change.

This notice does not change the end-of-life status of any product. Should product affected be on a previously issued product withdrawal/discontinuance notice, this notification does not extend the life of that product or change the life time buy offering/discontinuance plan.

For questions regarding this notice or to provide acknowledgement of this PCN, you may contact your local Field Sales Representative or the PCN Team (<u>PCN ww admin team@list.ti.com</u>). For sample requests or sample related questions, contact your local Field Sales Representative.

PCN Team SC Business Services

20200727000.1 Attachment: 1

Products Affected:

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

DEVICE

TPS22929DDBVR TPS22929DDBVT

CUSTOMER PART NUMBER

null

Technical details of this Product Change follow on the next page(s).

PCN Number: 20200727000.1 PCN Date: Aug. 3, 2020											
Title: Qualification of RFAB as an additional Fab site option for select LBC7 devices											
Customer Contact:			PCN Manager			Dept:			Quality Services		
-				Estimated Sample			-	Date provided at			
Proposed 1 st Ship Date:		te: NC	Nov. 3, 2020		Availability:			sample reque			
Change Ty	-										
Assembly Site			Assembly Process			Assembly Mate					
Design			Electrical Specification							chanical Specification	
Test Site			Packing/Shipping/Labelin							Process	
Wafer Bump Site			Wafer Bump Material						fer Bump Process		
Wafer Fab Site			Wafer Fab Materials				Wafer Fab Process			5	
	Part number change PCN Details										
Description	n of Chang	0 '	PCN	Dela	15						
			nnounce the	qualifica	tion of it	s RFA	B fa	brica	tion	facility as	an
			e selected de								an
	•										
		nt Site				ditio			-		
Current F Site	ab Pro	cess	Wafer Diameter		ional Site	Pr	oce	SS		Wafer ameter	
FFAB	LE	3C7	200 mm		AB	1	BC	7	-	00 mm	
			200 1111					,	5		
Qual details are provided in the Qual Data Section.											
Reason for	Change:										
Continuity of Supply											
Anticipate	Anticipated impact on Form, Fit, Function, Quality or Reliability (positive / negative):								e):		
None											-
	nroduct i	dontificat	ion resulting	1 from t	hic DCN	•					
changes to	produce in	uentineat	ion resulting	,		•					
Current:											
Current Ch	ip Site Ch	in Site Ori	gin Code (20L) Chir	Site Co	untrv	Сос	le (2	11.)	Chip Site	e Citv
FR-BIP-1			TID		DEU				/	Freising	
New Fab S	ite:										
New Chip	Site Ch	ip Site Ori	gin Code (20L	_) Chip	o Site Co	untry	Coo	de (2	1L)	Chip Site	e City
RFA	B	R	FB			USA				Richard	lson
Sample pro	duct shippin	g label (no	ot actual prod	uct labe	l)						
TEXAS											
$\begin{array}{c} \begin{array}{c} \text{MADE IN: Malaysia} \\ \text{2DC:} & 2\text{Q:} \end{array} \end{array} $											
MSL 2 /260C/1 YEAR SEAL DT RAGE (31T)LOT: 3959047MLA											
OPT: (P)											
ITEM:		39			2 P) REV: 20L) CSO		(2	1L) C	03331 CO:US		
LBL: 5A (L)T0:1750 $(20L)$ CSO: SHE $(21L)$ CCO:USA $(22L)$ ASO: MLA $(23L)$ ACO: MYS											
Product Af	fected:	1									
TLV7031DC	TLV7031DCKR TLV7041DPWR		PWR	TPS229	29DDBVT	/T TPS54			519RTET		
	TLV7031DPWR TPS22929DDBVR		DDBVR	TPS54519RTER			ד	TS3A225ERTER			

Qualification Report

Approve Date 6-October-2010

Qualification Results

Data Displayed as: Number of lots / Total sample size / Total failed

Туре	Test Name / Condition	Duration	Qual Device: TP\$51217D\$C	
ED	Electrical Characterization	Per Datasheet Parameters	Pass	
HAST	Biased HAST, 130C/85%RH	96 Hours	3/231/0	
AC	Autoclave, 121C	96 Hours	3/231/0	
HBM	ESD - HBM	2000 V	3/9/0	
CDM	ESD - CDM	500 V	3/9/0	
HTOL	Life Test, 135C	635 Hours	3/231/0	
HTSL	High Temp. Storage Bake, 170C	420 Hours	3/231/0	
LU	Latch-up	(per JESD78)	3/18/0	
TC	Temperature Cycle, -65/150C	500 Cycles	3/18/0	

- Qual Device TPS51217DSC is qualified at LEVEL2-260C

- Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable

- The following are equivalent HTOL options based on activation energy of 0.7eV: 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours

- The following are equivalent HTSL options based on activation energy of 0.7eV: 150C/1k Hours, and 170C/420 Hours - The following are equivalent Temp Cycle options per JESD47: -55C/125C/700 Cycles and -65C/150C/500 Cycles

Quality and Environmental data is available at TI's external Web site: http://www.ti.com/

Green/Pb-free Status:

Qualified Pb-Free (SMT) and Green

For questions regarding this notice, e-mails can be sent to the regional contacts shown below, or you can contact your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
WW PCN Team	PCN_ww_admin_team@list.ti.com

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